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CONGRESS OF THE UNITED STATES HOUSE OF REPRESENTATIVES

May 2nd, 2024

SUBCOMMITTEES:

INTERIOR, ENVIRONMENT, AND RELATED AGENCIES

ENERGY AND WATER DEVELOPMENT, AND RELATED AGENCIES

LABOR, HEALTH AND HUMAN SERVICES, EDUCATION, AND RELATED AGENCIES.

The Honorable Tom Cole, Chairman The Honorable Rosa DeLauro, Ranking Member House Committee on Appropriations H-307 the Capitol Washington, DC, 20515

Dear Chairman Cole and Ranking Member DeLauro,

I am requesting \$2.22 million in funding for the Microelectronics Research and Education project in fiscal year 2025. The entity to receive funding for this project is Boise State University, located at 1910 W University Dr, Boise, ID, 83725. This funding would be used to purchase research equipment including two plasma etch tools and an ion mill that will enhance Boise State University's research capabilities in developing new materials and processes in semiconductor and microelectronics manufacturing and improvement. This project is an appropriate use of taxpayer funds as Boise State University's continued research and innovation in the microelectronics and semiconductor spaces will keep the United States on the forefront of this incredibly important technology sector.

This project has a Federal nexus because the funding provided is for purposes described in Section 272 of Title 15, United States Code.

I certify that I have no financial interest in this project, and neither does anyone in my immediate family.

Sincerely

Mike Simpson

Member of Congress